N-Channel MOSFET



Dual N-Channel 30-V (D-S) MOSFET

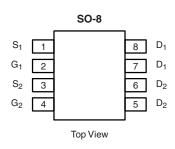
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A)		
30	0.035 at V _{GS} = 10 V	6.0		
	0.052 at V _{GS} = 4.5 V	4.9		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Compliant to RoHS Directive 2002/95/EC

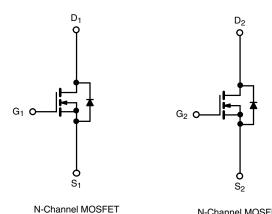






Ordering Information: Si9936BDY-T1-E3 (Lead (Pb)-free)

Si9936BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)



ABSOLUTE MAXIMUM RATINGS $T_A = 25 ^{\circ}C$, unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	30		V	
Gate-Source Voltage		V _{GS}	± 20			
Continuous Dusin Comment /T 150 90)8	T _A = 25 °C	I _D	6.0	4.5		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		4.8	3.6		
Pulsed Drain Current		I _{DM}	40		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	1.7	0.9		
M	T _A = 25 °C	P _D	2.0	1.1	W	
Maximum Power Dissipation ^a	T _A = 70 °C		1.3	0.7		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mariana landia la Ambiant	t ≤ 10 s	- R _{thJA}	53	62.5	°C/W
Maximum Junction-to-Ambient ^a	Steady State		92	110	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	30	40	

a. Surface Mounted on 1" x 1" FR4 board.

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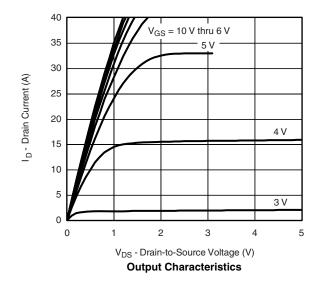
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.0		3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			1		
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α	
	В	V _{GS} = 10 V, I _D = 6 A		0.028	0.035	0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 4.9 A		0.041	0.052	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 6 A		12		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 1.7 A, V _{GS} = 0 V		0.8	1.2	V	
Dynamic ^b			•		•		
Total Gate Charge	Q_g			8.6	13		
Gate-Source Charge	Q_{gs}	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 6 A		1.8		nC	
Gate-Drain Charge	Q_{gd}			1.5		1	
Gate Resistance	R_{g}	f = 1 MHz		2.8		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r			15	25	ns	
Turn-Off Delay Time	t _{d(off)}			25	40		
Fall Time	t _f			10	15		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 1.7 A, dI/dt = 100 A/μs		20	40		

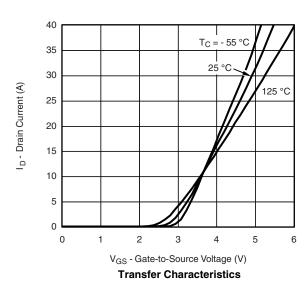
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

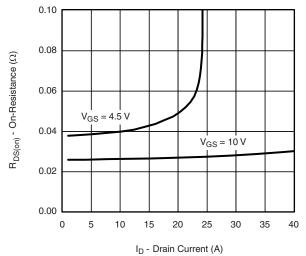
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



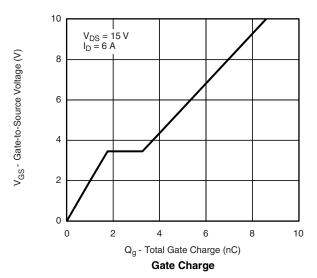


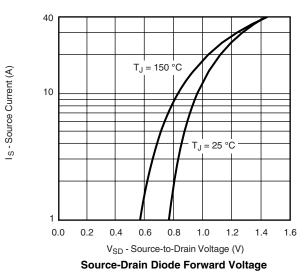


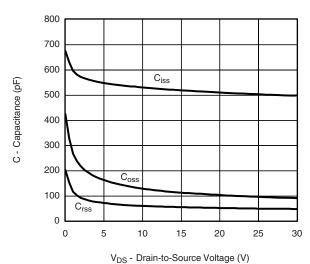
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



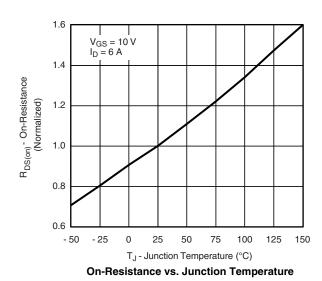
On-Resistance vs. Drain Current

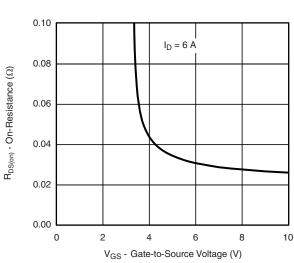






Capacitance

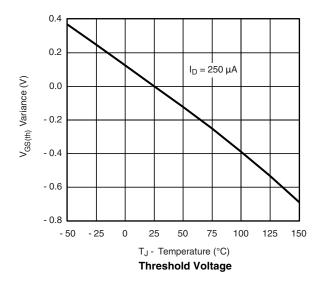


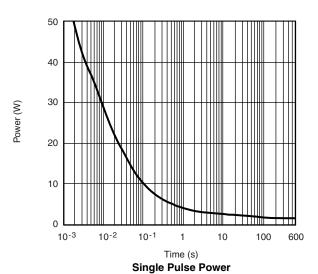


On-Resistance vs. Gate-to-Source Voltage

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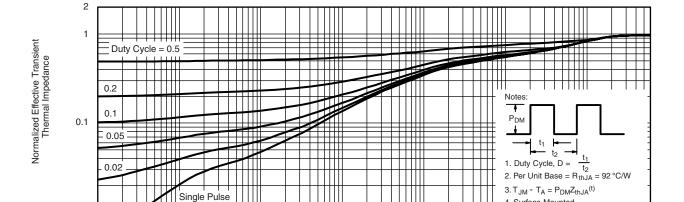
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





100 Limited by R_{DS(on)} P(t) = 0.000110 I_D - Drain Current (A) P(t) = 0.001P(t) = 0.01 шш P(t) = 0.1T_A = 25 °C Single Pulse LIÏIIII P(t) = 10.1 P(t) = 10DC I **BVDSS Limite** 0.01 0.1 100 V_{DS} - Drain-to-Source Voltage (V) * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area



10-1

10-2

10-3

Normalized Thermal Transient Impedance, Junction-to-Ambient

Square Wave Pulse Duration (s)

0.01 10-4

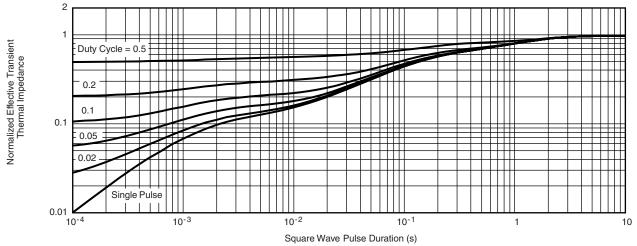
600

100

4. Surface Mounted



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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